



SSC8L410TN6

N-Channel Enhancement Mode MOSFET

➤ Features

V_{DS}	V_{GS}	$R_{DS(ON)}$ Typ.	I_D
40V	$\pm 20V$	5.9m Ω @10V	70A
		8.9m Ω @4V5	

➤ Description

This device is N-Channel enhancement MOSFET. Uses SGT technology and design to provide excellent RDSON with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit.

100% UIS + ΔV_{DS} + R_g Tested!

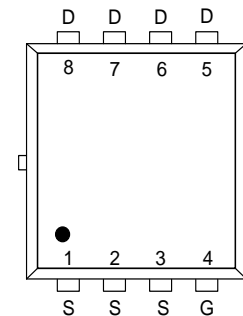
➤ Applications

- Motor Drive Control
- DCDC Conversion
- Power Supplies
- Synchronous Rectification

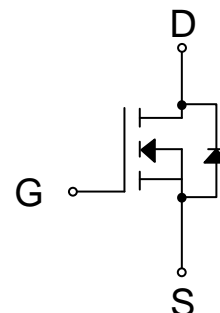
➤ Ordering Information

Device	Package	Shipping
SSC8L410TN6	PDFN5X6-8L	5000/Reel

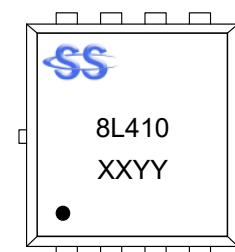
➤ Pin Configuration



PDFN5X6-8L (Top View)



Pin Configuration



Marking

(XXYY: Internal Traceability Code)

**➤ Absolute Maximum Ratings (T_A=25°C unless otherwise noted)**

Symbol	Parameter		Ratings	Unit
V _{DSS}	Drain-to-Source Voltage		40	V
V _{GSS}	Gate-to-Source Voltage		±20	V
I _D	Continuous Drain Current ^d	T _C =25°C	70	A
		T _C =100°C	38	
I _{DSM}	Continuous Drain Current ^a	T _A =25°C	20	A
		T _A =70°C	15	
I _{DM}	Pulsed Drain Current ^b		250	A
P _D	Power Dissipation ^c	T _C =25°C	50	W
		T _C =100°C	20	
P _{DSM}	Power Dissipation ^a	T _A =25°C	4.17	W
		T _A =70°C	2.63	
I _{AS}	Avalanche Current ^b L=0.5mH Single Pulse		15	A
E _{AS}	Avalanche Energy ^b L=0.5mH Single Pulse		56.25	mJ
T _J	Operation junction temperature		-55~150	°C
T _{STG}	Storage temperature range		-55~150	

➤ Thermal Resistance Ratings (T_A=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
R _{θJA}	Junction-to-Ambient Thermal Resistance ^a	30	°C/W
R _{θJC}	Junction-to-Case Thermal Resistance	2.5	

Note:

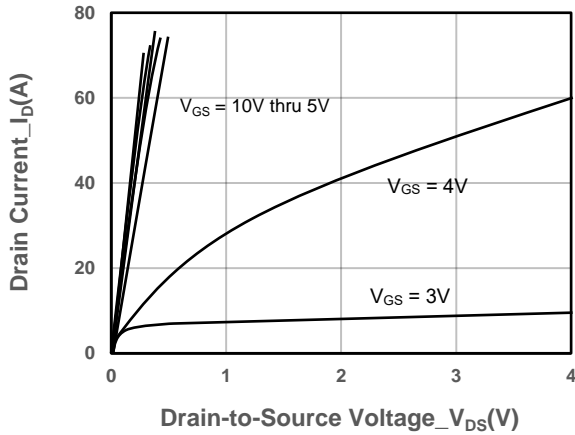
- The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with T_A=25°C. The value in any given application depends on the user is specific board design. The power dissipation is based on the t≤10s thermal resistance rating.
- Repetitive rating, pulse width limited by junction temperature.
- The power dissipation P_D is based on T_{J(MAX)}=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- The maximum current rating is package limited.

**➤ Electrical Characteristics (T_A=25°C unless otherwise noted)**

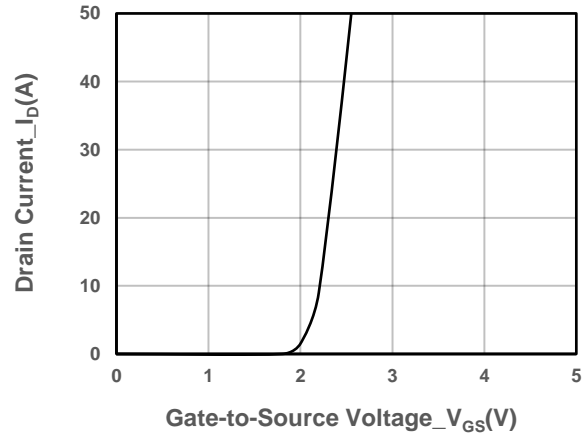
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	40			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250uA	1	1.5	2.5	V
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = 10V, I _D = 12A		5.9	7.7	mΩ
		V _{GS} = 4.5V, I _D = 10A		8.9	12	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 40V, V _{GS} = 0V			1	μA
Gate-Source Leak Current	I _{GSS}	V _{GS} = ±20V, V _{DS} = 0V			±100	nA
Forward Voltage	V _{SD}	V _{GS} = 0V, I _S = 1A		0.78	1.2	V
Gate Resistance	R _G	V _{DS} = 0V, f = 1MHz		3.7		Ω
Input Capacitance	C _{ISS}	V _{DS} = 20V, V _{GS} = 0V, f = 1MHz		650		pF
Output Capacitance	C _{OSS}			360		
Reverse Transfer Capacitance	C _{RSS}			18		
Total Gate Charge	Q _G	V _{GS} = 10V, V _{DS} = 20V, I _D = 12A		11.5		nC
Gate to Source Charge	Q _{GS}			2.1		
Gate to Drain Charge	Q _{GD}			2.2		
Turn-on Delay Time	T _{D(ON)}	V _{GS} = 10V, V _{DS} = 15V, I _D = 1A, R _G = 3.3Ω		8		ns
Rise Time	T _r			6		
Turn-off Delay Time	T _{D(OFF)}			34		
Fall Time	T _f			10		
Diode Recovery Time	T _{rr}	I _F =20A, di/dt=500A/us		25		ns
Diode Recovery Charge	Q _{rr}	I _F =20A, di/dt=500A/us		60		nC



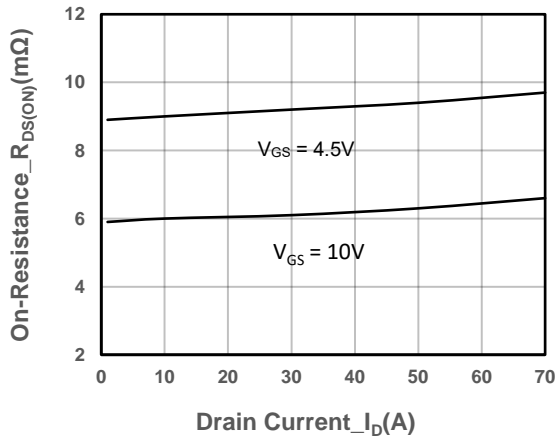
➤ Typical Performance Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)



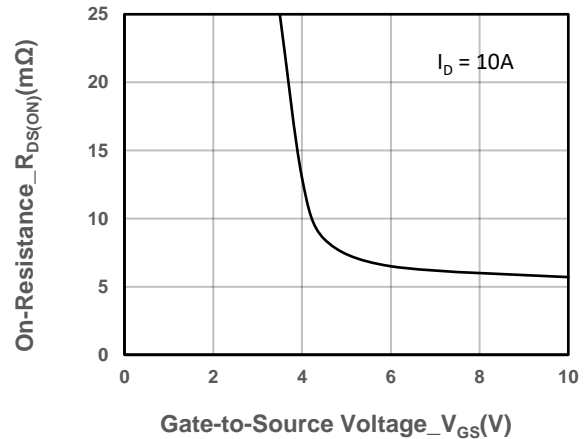
Output Characteristics



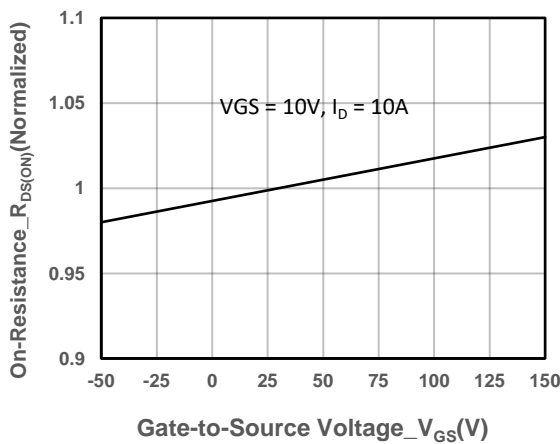
Transfer Characteristics



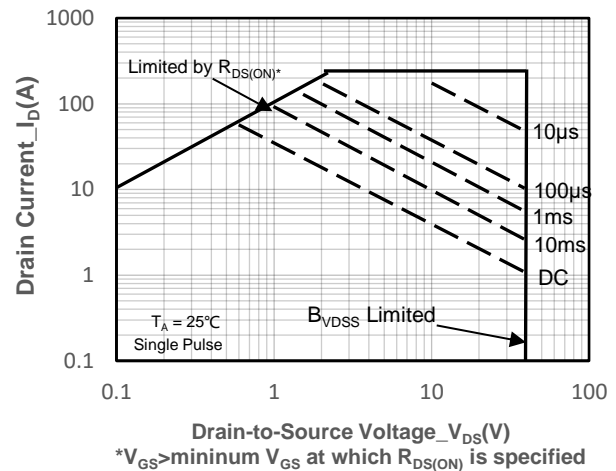
On-Resistance vs. Drain Current and Gate Voltage



On-Resistance vs. Gate-to-Source Voltage

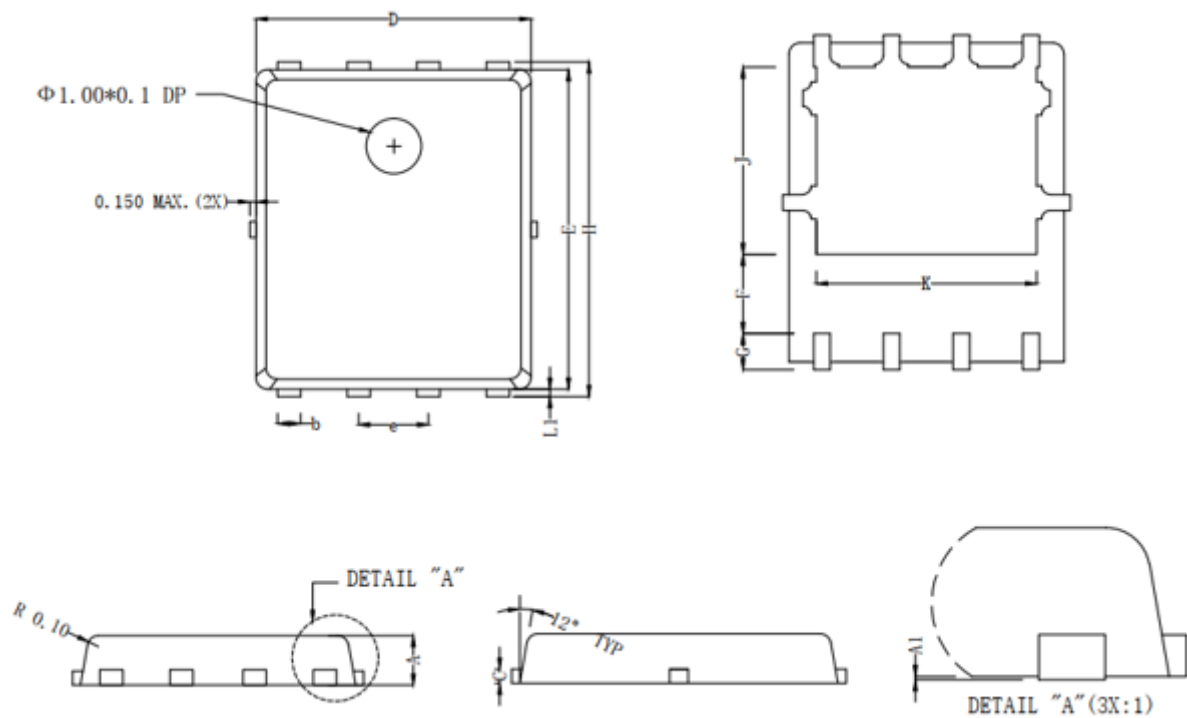


On-Resistance vs. Junction Temperature



Safe Operating Area vs. Junction-to-Ambient

➤ Package Information



Symbol	Dimensions In Millimeters		
	Min.	Nom.	Max.
A	0.90	1.00	1.10
A1	0.00	0.03	0.05
b	0.25	0.03	0.35
c	0.254 REF		
D	4.80	4.90	5.00
F	1.35 REF		
E	5.65	5.75	5.85
e	1.27 BSC		
H	5.90	6.00	6.10
L1	0.10	0.13	0.16
G	0.55 REF		
K	4.00 REF		
J	3.45 REF		



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